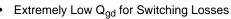


N-Channel 150 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
150	0.080 at V _{GS} = 10 V	5.4	23 nC			
150	0.085 at V _{GS} = 8 V	4.5	23110			

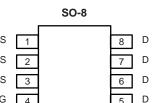
FEATURES • Halogen-free According to IEC 61249-2-21

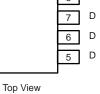


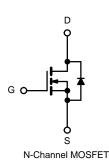


- 100 % R_g Tested
- 100 % Avalanche Tested
- Compliant to RoHS Directive 2002/95/EC









APPLICATIONS

Primary Side Switch

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V_{DS}	150	V	
Gate-Source Voltage		V_{GS}	± 20		
	T _C = 25 °C		5.4		
Continuous Drain Current (T. 450 °C)	T _C = 70 °C	1 1	5.1		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	5.0 ^{b, c}		
	T _A = 70 °C		4.5 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	22		
Continuous Source-Drain Diode Current	T _C = 25 °C	4.5	4.5		
Continuous Source-Diam Diode Current	T _A = 25 °C	I _S	2.6 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Single Pulse Avalanche Energy		E _{AS}	20	mJ	
	T _C = 25 °C		5.9		
Maximum Power Dissipation	T _C = 70 °C]	3.8	W	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.1 ^{b, c}	VV	
	T _A = 70 °C	1	2 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stq}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, †}	t ≤ 10 s	R_{thJA}	33	40	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	17	21			

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 80 °C/W.



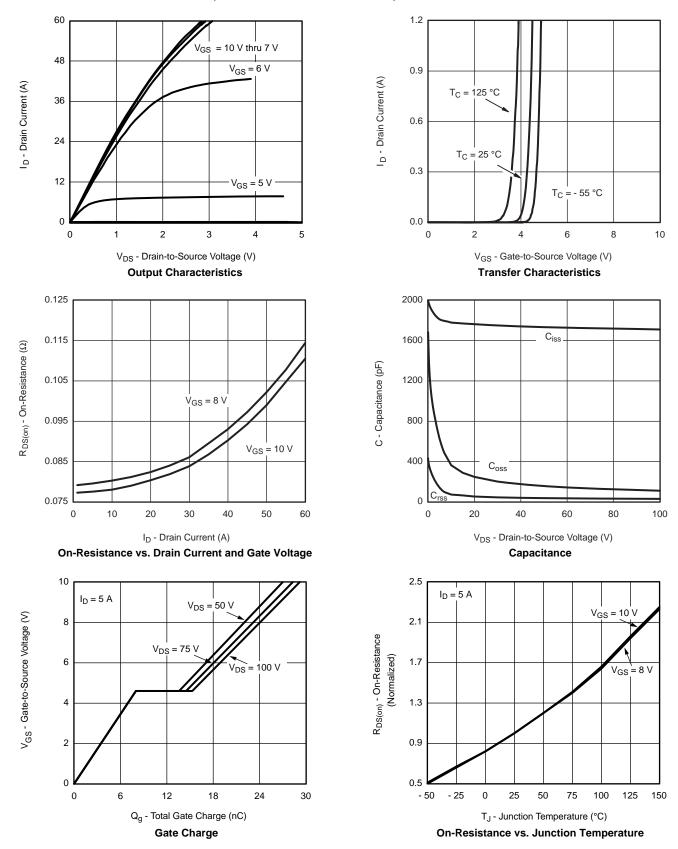
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					1	ı	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$	150			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			172		>//00	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_{J}$	$I_D = 250 \mu A$		- 10		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu\text{A}$	1.2		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
7 0 1 1/1 5 1 0 1	I _{DSS} -	V _{DS} = 100 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 55 °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
Davis Course On Otata Basistana 3	`	V _{GS} = 10 V, I _D = 5 A	0.080 0.09		0.090		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 8 \text{ V, } I_{D} = 5 \text{ A}$		0.085	0.095	5 Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 5 A		23		S	
Dynamic ^b		-					
Input Capacitance	C _{iss}			1735			
Output Capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		160		pF	
Reverse Transfer Capacitance	C _{rss}			37			
Total Gate Charge	Q _g	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		28.5	43	nC	
				23	35		
Gate-Source Charge	Q_{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 8 \text{ V}, I_{D} = 5 \text{ A}$		8			
Gate-Drain Charge	Q _{gd}			6.5			
Gate Resistance	R _g	f = 1 MHz		0.85	1.3	Ω	
Turn-on Delay Time	t _{d(on)}			14	21		
Rise Time	t _r	V_{DD} = 50 V, R_L = 10 Ω		12	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		22	33		
Fall Time	t _f			6	10	no	
Turn-On Delay Time	t _{d(on)}			16	24	ns	
Rise Time	t _r	V_{DD} = 50 V, R_L = 10 Ω		12	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5$ A, $V_{GEN} = 8$ V, $R_g = 1$ Ω		20	30		
Fall Time	t _f			7	12		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			7.7	Α	
Pulse Diode Forward Current ^a	I _{SM}				50	_ ^	
Body Diode Voltage	V _{SD}	I _S = 2.6 A		0.77	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			63	95	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 5 A, dl/dt = 100 A/μs, T _J = 25 °C		110	165	nC	
Reverse Recovery Fall Time	t _a	1F - 3 Λ, αι/αι = 100 Λ/μ5, 1J = 25 C		49		ns	
Reverse Recovery Rise Time	t _b			14		113	

Notes:

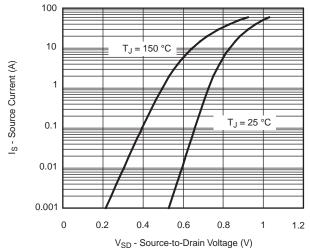
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- a. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

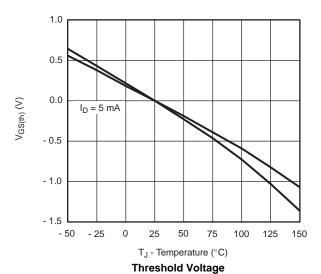




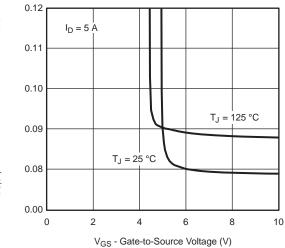




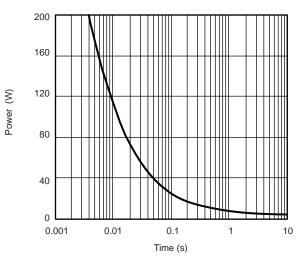
Source-Drain Diode Forward Voltage



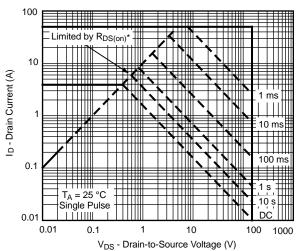
 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - Drain-to-Source On-Resistance (Ω)



On-Resistance vs. Gate-to-Source Voltage



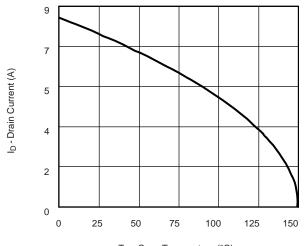
Single Pulse Power, Junction-to-Ambient



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

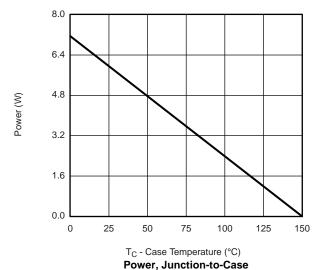
Safe Operating Area, Junction-to-Ambient

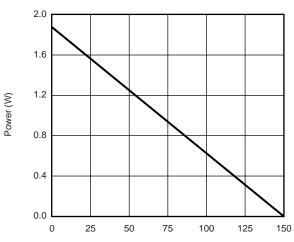




T_C - Case Temperature (°C)





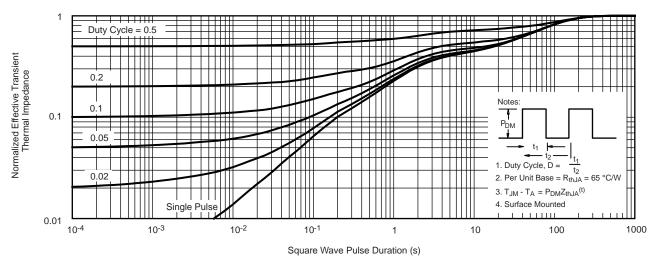


T_A - Ambient Temperature (°C)

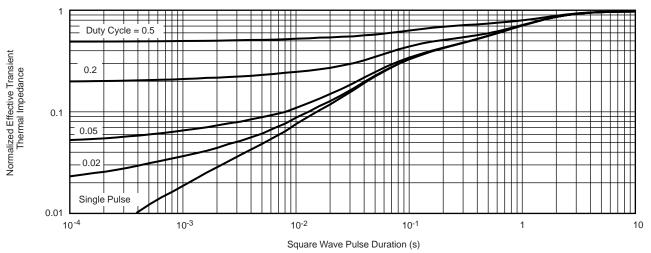
Power, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
FCN: C-06527-Rev I 11-Sen-06						

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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